PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TETSUO NOGUCHI	08/17/2016
TAKESHI OHTSUKA	08/12/2016
MASANORI MATSUMOTO	08/18/2016
YUICHI SHINDO	08/17/2016

RECEIVING PARTY DATA

Name:	DENKA COMPANY LIMITED
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State/Country:	JAPAN
Postal Code:	1038338

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15216265

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	0271.1011D1	
NAME OF SUBMITTER:	MICHAEL D. STEIN	
SIGNATURE:	/Michael D. Stein/	
DATE SIGNED:	09/06/2016	

Total Attachments: 2

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> **PATENT** REEL: 039640 FRAME: 0743

503992457

Docket No.: 0271.1011D1

COMBINED DECLARATION/ASSIGNMENT FOR UTILITY/DESIGN PATENT APPLICATION

OATH OR DECLARATION

As a below named inventor, I hereby declare that:

This combined declaration and assignment is directed to the application entitled:

COPOLYMER FOR IMPROVING METHACRYLIC RESIN HEAT RESISTANCE
the specification of which is attached hereto, or was filed on July 21, 2016 as United States Application Number (or PCT International Application
Number) 15/216.265 and was amended on (if applicable).
Any registered attorney of STEIN IP, LLC, 1400 Eye St., N.W., Suite 300, Washington, D.C. 20005 (202-216-9505), USPTO Customer Number 49,455, is hereby authorized to insert the specified data into the above paragraph, when known.
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.
<u>ASSIGNMENT</u>
IN CONSIDERATION of good and valuable consideration paid to me, an undersigned inventor, by
Denka Company Limited 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku Tokyo, 103-8338 Japan
(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, I hereby sell, assign and transfer to ASSIGNEE the entire and exclusive right, title and interest to the above-identified application and the claimed invention therein, and any continuation, division, renewal, substitute, reissue or reexamination application based thereon (collectively, hereinafter, "said application(s)"), and all Letters Patent of the United States granted on said application(s), for the full term or terms for which the said Letters Patent may be granted and including any extensions thereof (collectively, hereinafter, "said Letters Patent").
I agree, when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent, in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful paths, providing sworn testimony, and obtaining and producing evidence.
I covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.
IN WITNESS WHEREOF, I have affixed my signature on the date beneath.
Full name of sole/first inventor Tetsuc NOGUCHI
Inventor's Signature Tetsuo Naguchi Executed August 17, 2016
Inventor's Mailing Address <u>c/o Denka Company Limited, Chiba Kojo, 6 Goiminamikaigan, Ichihara-city, Chiba 2908588 Japan</u> Inventor's Residence <u>c/o Denka Company Limited, Chiba Kojo, 6 Goiminamikaigan, Ichihara-city, Chiba 2908588 Japan</u>
Full name of second inventor Takeshi OHTSUKA
Inventor's Signature Takeshi Otsuka Executed August 12, 2016

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rull hame of third inventor <u>Iviasan</u>	UI MATSUMUTU	*****		
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